Memory FRAM CMOS 1 M Bit (128 K × 8)

MB85R1001

DESCRIPTIONS

The MB85R1001 is an FRAM (Ferroelectric Random Access Memory) chip consisting of 131,072 words x 8 bits of non-volatile memory cells created using ferroelectric process and silicon gate CMOS process technologies.

The MB85R1001 is able to retain data without using a back-up battery, as is needed for SRAM.

The memory cells used in the MB85R1001 can be used for at least 10¹⁰ read/write operations, which is a significant improvement over the number of read and write operations supported by Flash memory and E²PROM.

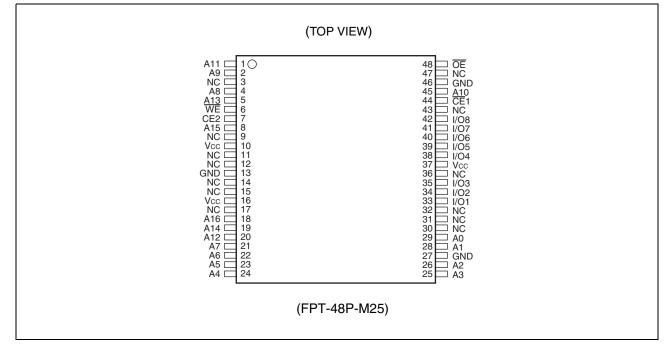
The MB85R1001 uses a pseudo-SRAM interface that is compatible with conventional asynchronous SRAM.

FEATURES

- Bit configuration
- : 131,072 words \times 8bits Bit configuration : 131,072 words × 86
 Read/write endurance : 10¹⁰ times/bit (Min)
- Operating power supply voltage : 3.0 V to 3.6 V
- Operating temperature range : 20 °C to + 85 °C
- Data retention
- Package

- : 10 years (+ 55 °C)
- : 48-pin plastic TSOP (1)

■ PIN ASSIGNMENTS

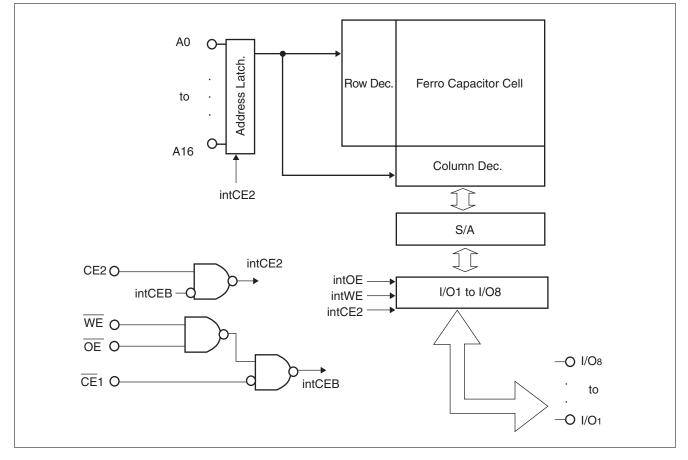


■ PIN DESCRIPTIONS

Pin name	Function
A0 to A16	Address In
I/O1 to I/O8	Data Input/Output
CE1	Chip Enable 1 in
CE2	Chip Enable 2 in
WE	Write Enable in
ŌE	Output Enable in
Vcc	Power Supply
GND	Ground
NC	No Connection

MB85R1001

■ BLOCK DIAGRAM



■ FUNCTION TRUTH TABLE

Operation Mode	CE1	CE2	WE	OE	I/O1 to I/O8	Supply Current	
	Н	Х	Х	Х		Quantil	
Standby Pre-charge	Х	L	Х	Х	High-Z	Standby (IsB)	
	Х	Х	Н	Н		(105)	
Read		H	Н	L			
	L				Dout	Operation	
Read (Pseudo-SRAM, OE control*1)	L	Н	Н	Ł			
W/rite	7	Н		Н		(Icc)	
Write	L	Ā	L	П	Din		
Write (Pseudo-SRAM, WE control*²)	L	Н	لح	Н			

 $L = V_{IL}, H = V_{IH}, X$ can be either V_{IL} or $V_{IH},$ High-Z = High Impedance

 γ : Latch address and latch data at falling edge, $rac{1}{2}$: Latch address and latch data at rising edge

*1 : \overline{OE} control of the Pseudo-SRAM means the valid address at the falling edge of \overline{OE} to read.

*2: WE control of the Pseudo-SRAM means the valid address and data at the falling edge of WE to write.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rat	Unit	
Farameter	Symbol	Min	Мах	Unit
Supply Voltage*	Vcc	- 0.5	+ 4.0	V
Input Voltage*	VIN	- 0.5	Vcc + 0.5	V
Output Voltage*	Vout	- 0.5	Vcc + 0.5	V
Ambient Operating Temperature	TA	- 20	+ 85	°C
Storage Temperature	Tstg	- 40	+ 125	°C

* : All voltages are referenced to GND.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol		Unit		
Falameter	Symbol	Min	Тур	Мах	Onit
Supply Voltage*	Vcc	3.0	3.3	3.6	V
Input Voltage (high)*	Vін	$V_{\text{CC}} imes 0.8$	—	Vcc + 0.5	V
Input Voltage (low)*	VIL	- 0.5		+ 0.8	V
Operating Temperature	TA	- 20	—	+ 85	°C

* : All voltages are referenced to GND.

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges. Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

ELECTRICAL CHARACTERISTICS

1. DC CHARACTERISTICS

(within recommended operating conditions)

Parameter Symbol		Test Condition		Unit		
Faranieter	Symbol	Test Condition	Min	Тур	Max	Unit
Input Leakage Current	llul	$V_{IN} = 0 V \text{ to } V_{CC}$	—	—	10	μA
Output Leakage Current	lliol	$\label{eq:Vout} \begin{array}{l} V_{\text{OUT}} = 0 \ V \ \text{to} \ V_{\text{CC}}, \\ \hline \overline{\text{CE}} 1 = V_{\text{IH}} \ \text{or} \ \overline{\text{OE}} = V_{\text{IH}} \end{array}$			10	μA
Operating Power Supply Current	Icc	$\overline{CE}1 = 0.2 \text{ V}, \text{ CE2} = \text{V}_{\text{CC}}-0.2 \text{ V},$ $I_{\text{out}} = 0 \text{ mA}^{*1}$		10	15	mA
		$\overline{CE}1 \ge V_{CC}-0.2 V$				
Standby Current	lsв	CE2 ≤ 0.2 V*2	—	10	50	μA
		$\overline{OE} \ge V_{CC} - 0.2 \text{ V}, \ \overline{WE} \ge V_{CC} - 0.2 \text{ V}^{*2}$				
Output Voltage (high)	Vон	Iон = -0.1 mA	Vcc imes 0.8			V
Output Voltage (low)	Vol	$I_{OL} = 2.0 \text{ mA}$			0.4	V

*1 : During the measurement of I_{CC} , the Address, Data In were taken to only change once per active cycle. I_{out} : output current

*2 : All pins other than setting pins should be input at the CMOS level voltages such as H \geq Vcc - 0.2 V, L \leq 0.2 V.

2. AC CHARACTERISTICS

• AC TEST CONDITIONS

Supply Voltage	: 3.0 V to 3.6 V
Operating Temperature	: –20 °C to +85 °C
Input Voltage Amplitude	: 0.3 V to 2.7 V
Input Rising Time	: 5 ns
Input Falling Time	: 5 ns
Input Evaluation Level	: 2.0 V / 0.8 V
Output Evaluation Level	: 2.0 V / 0.8 V
Output Impedance	: 50 pF

(1) Read Operation

(within recommended operating conditions)

Parameter	Symbol	Va	lue	Unit	
Falanielei	Symbol		Max		
Read Cycle Time	trc	150		ns	
CE1 Active Time	t _{CA1}	120		ns	
CE2 Active Time	tca2	120		ns	
OE Active Time	t _{RP}	120		ns	
Pre-charge Time	tec	20		ns	
Address Setup Time	tas	0		ns	
Address Hold Time	tан	50		ns	
OE Setup Time	tes	0		ns	
Output Hold Time	tон	0		ns	
Output Set Time	t∟z	30		ns	
CE1 Access Time	t _{CE1}		100	ns	
CE2 Access Time	tCE2		100	ns	
OE Access Time	toe		100	ns	
Output Floating Time	tонz		20	ns	

(2) Write Operation

(within recommended operating condit

Parameter	Symbol	Va	lue	Unit
Falameter	Symbol	Min	Мах	Unit
Write Cycle Time	twc	150		ns
CE1 Active Time	t _{CA1}	120		ns
CE2 Active Time	tca2	120		ns
Pre-charge Time	tPC	20		ns
Address Setup Time	tas	0		ns
Address Hold Time	tан	50	_	ns
Write Pulse Width	twp	120		ns
Data Setup Time	tos	0		ns
Data Hold Time	tон	50		ns
Write Setup Time	tws	0		ns

(3) Power ON/OFF Sequence

(within recommended operating conditions)

Parameter	Sym-			Unit	
Falameter	bol	Min	Тур	Max	Unit
CE1 level hold time for Power OFF	t _{pd}	85	_		ns
CE1 level hold time for Power ON	tpu	85	—		ns

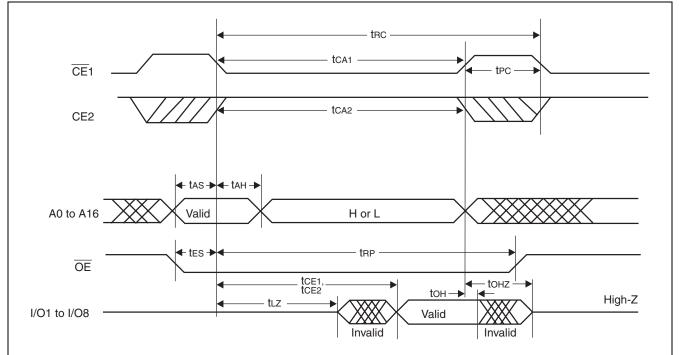
3. Pin Capacitance

(f = 1 MHz, T_A = +25 °C)

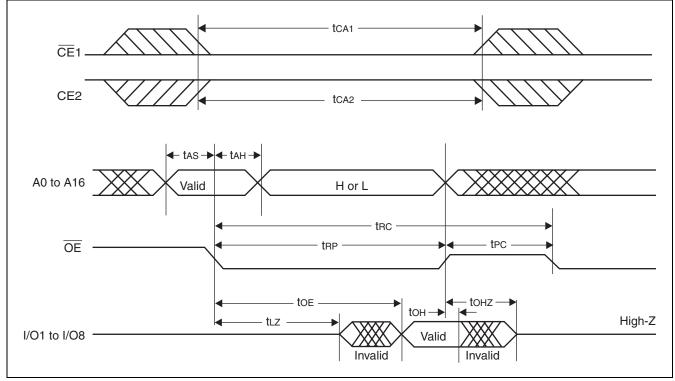
Parameter	Symbol	Test Condition		Value		Unit
Farameter	Symbol	Test Condition	Min	Тур	Max	Onn
Input Capacitance	CIN	$V_{\text{IN}} = GND$			10	pF
Output Capacitance	Соит	Vout = GND			10	pF

■ TIMING DIAGRAMS

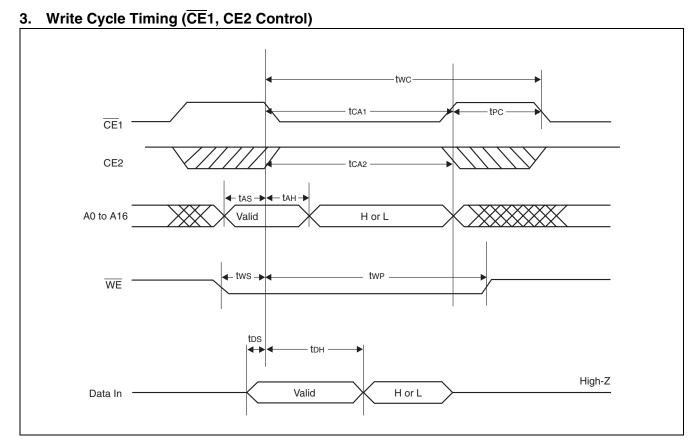
1. Read Cycle Timing (CE1, CE2 Control)



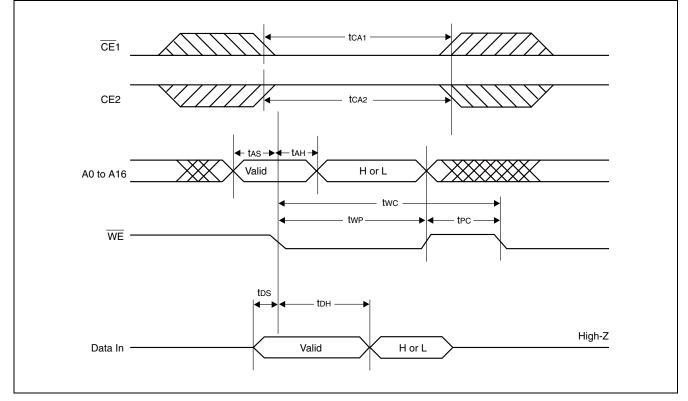
2. Read Cycle Timing (OE Control)



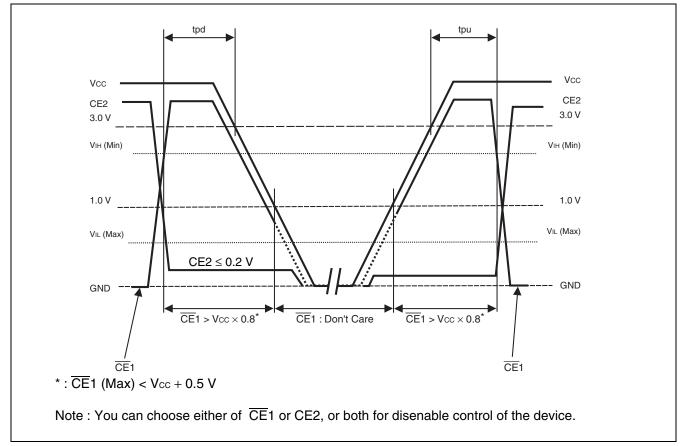
MB85R1001



4. Write Cycle Timing (WE Control)



■ POWER ON/OFF SEQUENCE



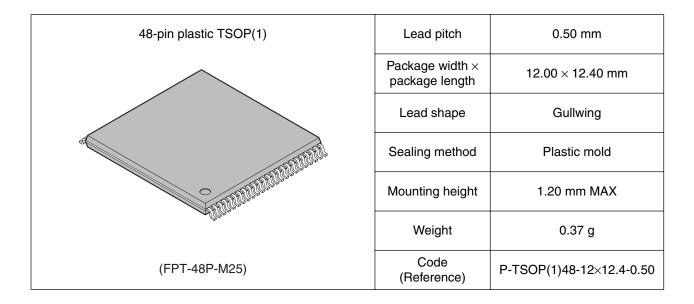
■ NOTES ON USE

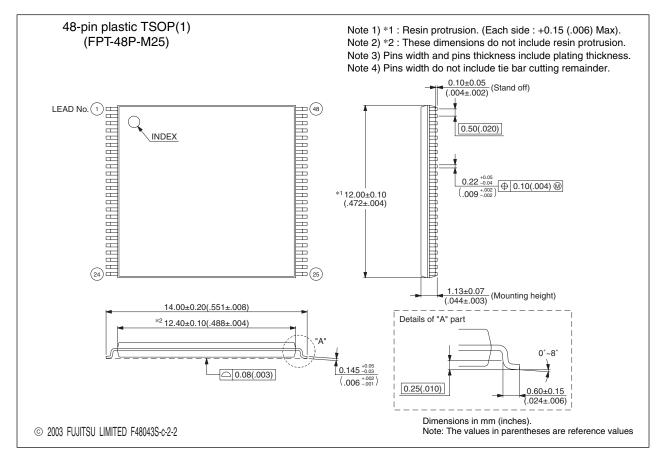
Data that is written prior to IR reflow is not guaranteed to be retained after IR reflow.

ORDERING INFOMATION

Part number	Package
MB85R1001PFTN-GE1	48-pin plastic TSOP(1) (FPT-48P-M25)

PACKAGE DIMENSIONS





Please confirm the latest Package dimension by following URL. http://edevice.fujitsu.com/fj/DATASHEET/ef-ovpklv.html

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